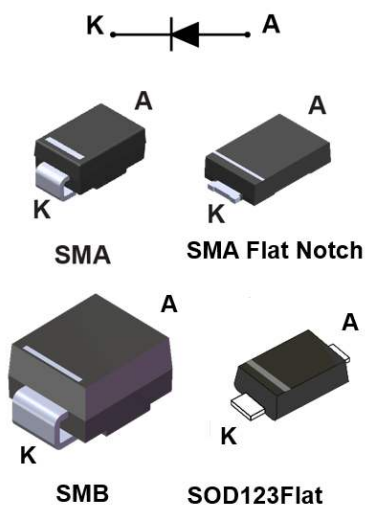


## 40 V, 1 A low drop power Schottky rectifier



### Features

- Very small conduction losses
- Negligible switching losses
- Low forward voltage drop
- Surface mount miniature packages
- Avalanche rated
- ECOPACK2 compliant

### Applications

- Reverse polarity protection
- Set-top box power supply
- TV power supply
- Battery charger

### Description

Single chip Schottky rectifiers suited to switched mode power supplies and high frequency DC to DC converters.

Packaged in SMA, SMA Flat Notch, SMB and SOD123Flat, the **STPS1L40** is ideal for use in surface mounting and used in low voltage, high frequency inverters, free-wheeling and polarity protection applications.

Product status	
STPS1L40	
Product summary	
Symbol	Value
$I_{F(AV)}$	1 A
$V_{RRM}$	40 V
$T_{j(max.)}$	175 °C
$V_{F(typ.)}$	0.37 V

# 1 Characteristics

**Table 1. Absolute ratings (limiting values at 25 °C, unless otherwise specified)**

Symbol	Parameter		Value	Unit
$V_{RRM}$	Repetitive peak reverse voltage		40	V
$I_{F(RMS)}$	Forward rms current	SMA/SMB	8	A
$I_{F(AV)}$	Average forward current $\delta = 0.5$ , square wave	SMA/SMB $T_L = 155\text{ °C}$	1	A
		SMA Flat Notch $T_L = 160\text{ °C}$		
		SOD123Flat $T_L = 160\text{ °C}$		
$I_{FSM}$	Surge non repetitive forward current	SMA/SMB	60	A
		SMA Flat Notch $t_p = 10\text{ ms sinusoidal}$	60	
		SOD123Flat	50	
$P_{ARM}$	Repetitive peak avalanche power	$t_p = 10\text{ }\mu\text{s}, T_j = 125\text{ °C}$	65	W
$T_{stg}$	Storage temperature range		-65 to +175	°C
$T_j$	Operating junction temperature <sup>(1)</sup>		+175	°C

1.  $(dP_{tot}/dT_j) < (1/R_{th(j-a)})$  condition to avoid thermal runaway for a diode on its own heatsink.

**Table 2. Thermal resistance parameter**

Symbol	Parameter		Max. value	Unit
$R_{th(j-l)}$	Junction to lead	SMA	30	°C/W
		SMA Flat Notch	20	
		SMB	25	
		SOD123Flat	20	

For more information, please refer to the following application note :

- AN5088 : Rectifiers thermal management, handling and mounting recommendations

**Table 3. Static electrical characteristics**

Symbol	Parameter	Test conditions		Min.	Typ.	Max.	Unit
$I_R^{(1)}$	Reverse leakage current	$T_j = 25\text{ °C}$	$V_R = V_{RRM}$	-		35	$\mu\text{A}$
		$T_j = 125\text{ °C}$		-	6	10	mA
$V_F^{(1)}$	Forward voltage drop	$T_j = 25\text{ °C}$	$I_F = 1\text{ A}$	-		0.50	V
		$T_j = 125\text{ °C}$		-	0.37	0.42	
		$T_j = 25\text{ °C}$	$I_F = 2\text{ A}$	-		0.63	
		$T_j = 125\text{ °C}$		-	0.50	0.61	

1. Pulse test:  $t_p = 380\text{ }\mu\text{s}$ ,  $\delta < 2\%$

To evaluate the conduction losses, use the following equation:

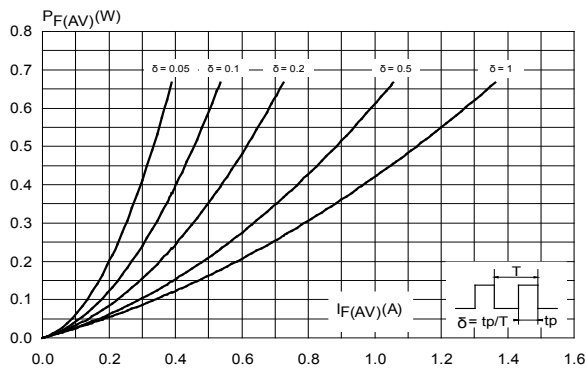
$$P = 0.23 \times I_{F(AV)} + 0.19 \times I_{F(RMS)}^2$$

For more information, please refer to the following application notes related to the power losses :

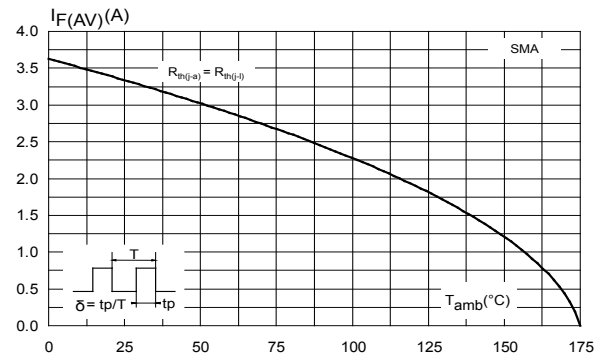
- AN604: Calculation of conduction losses in a power rectifier
- AN4021: Calculation of reverse losses on a power diode

## 1.1 Characteristics (curves)

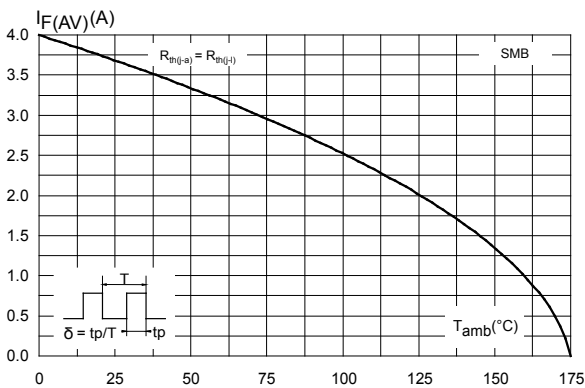
**Figure 1. Average forward power dissipation versus average forward current**



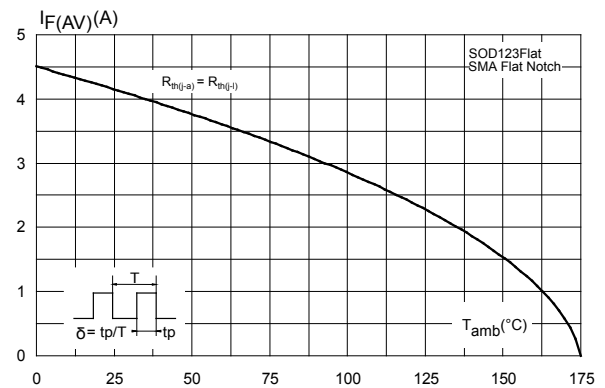
**Figure 2. Average forward current versus ambient temperature (SMA,  $\delta = 0.5$ )**



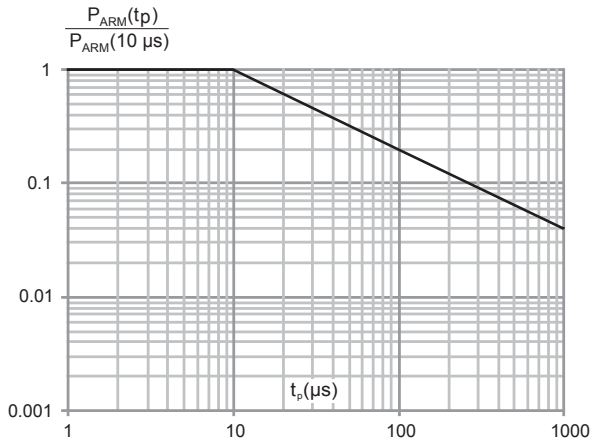
**Figure 3. Average forward current versus ambient temperature (SMB,  $\delta = 0.5$ )**



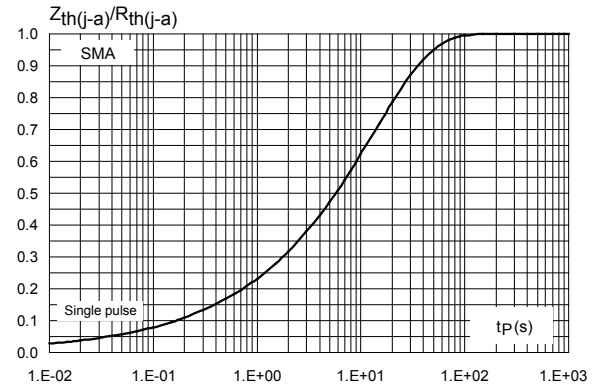
**Figure 4. Average forward current versus ambient temperature (SOD123Flat, SMA Flat Notch,  $\delta = 0.5$ )**



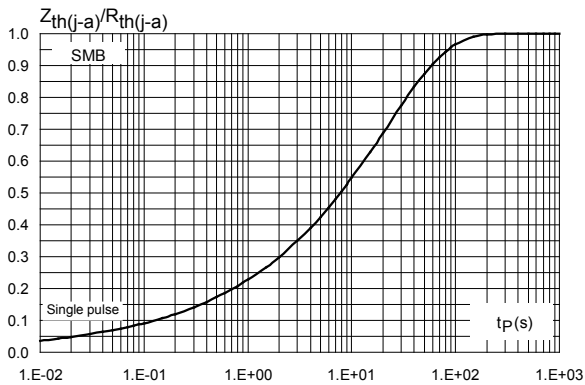
**Figure 5. Normalized avalanche power derating versus pulse duration ( $T_j = 125\text{ }^\circ\text{C}$ )**



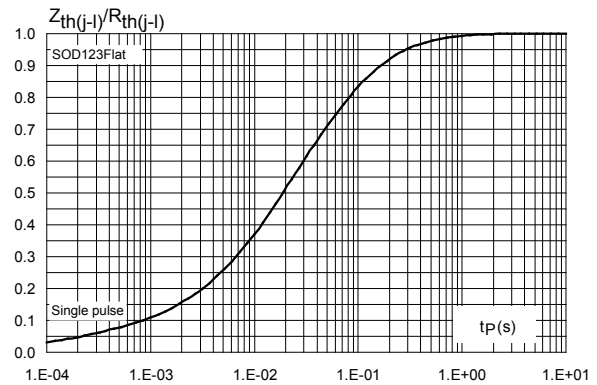
**Figure 6. Relative variation of thermal impedance junction to ambient versus pulse duration (SMA)**



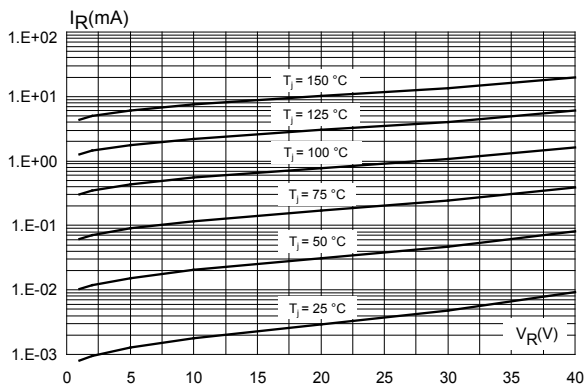
**Figure 7. Relative variation of thermal impedance junction to ambient versus pulse duration (SMB)**



**Figure 8. Relative variation of thermal impedance junction to lead versus pulse duration (SOD123Flat)**



**Figure 9. Reverse leakage current versus reverse voltage applied (typical values)**



**Figure 10. Junction capacitance versus reverse voltage applied (typical values)**

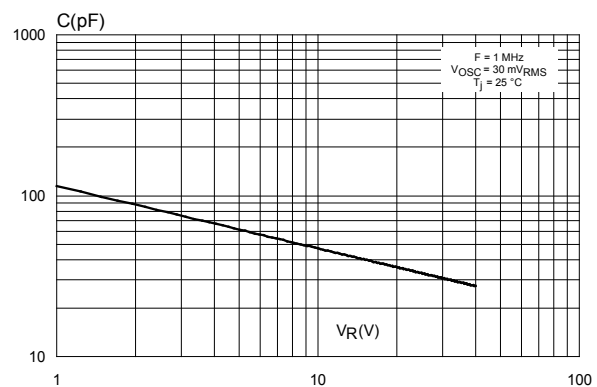


Figure 11. Forward voltage drop versus forward current (typical values)

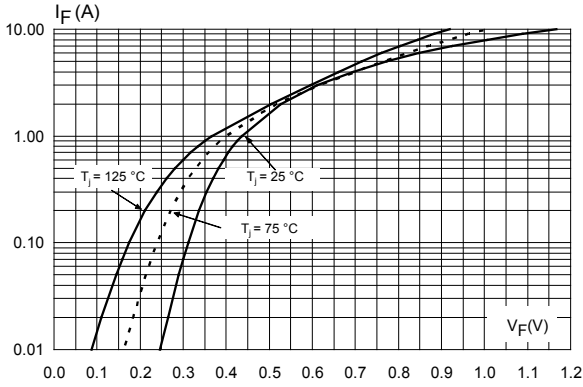


Figure 12. Thermal resistance junction to ambient versus copper surface under each lead (typical values)

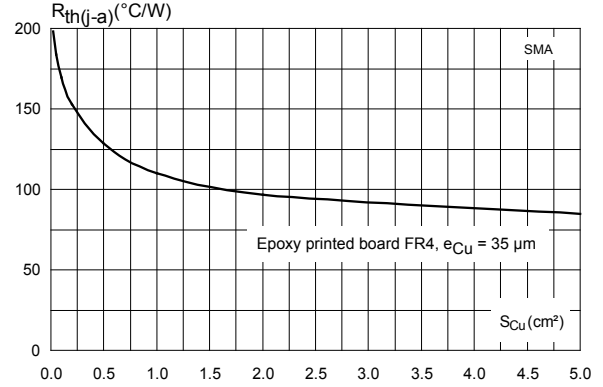


Figure 13. Thermal resistance junction to ambient versus copper surface under each lead (typical values)

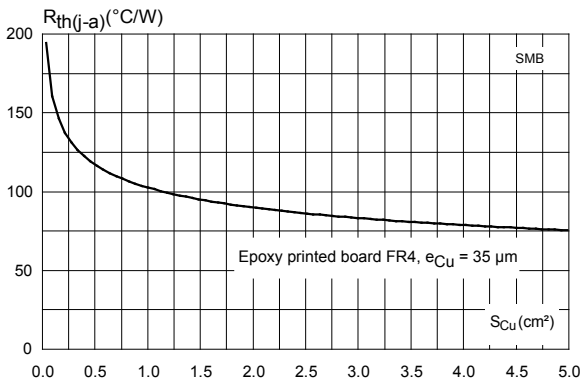


Figure 14. Thermal resistance junction to ambient versus copper surface under each lead (typical values)

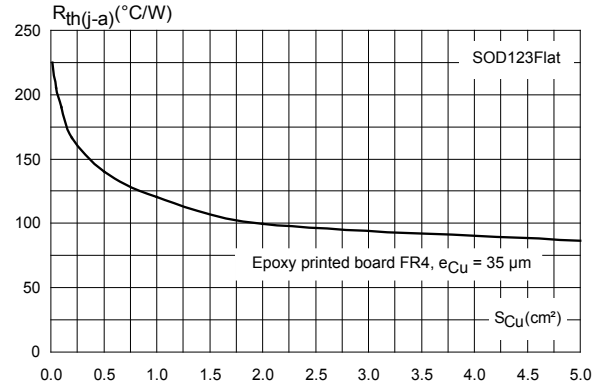
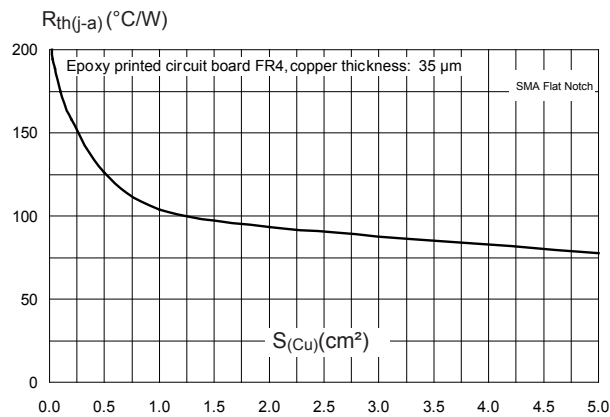


Figure 15. Thermal resistance junction to ambient versus copper surface under each lead (SMA Flat Notch)



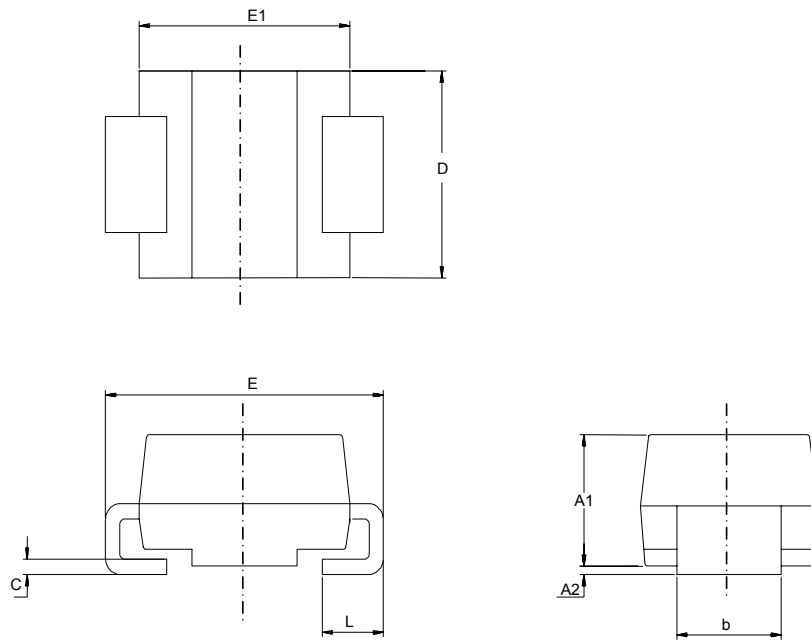
## 2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of **ECOPACK** packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

### 2.1 SMB package information

- Epoxy meets UL94, V0
- Lead-free package

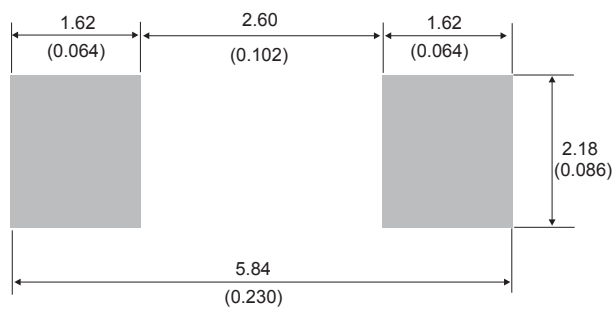
**Figure 16. SMB package outline**



**Table 4. SMB package mechanical data**

Ref.	Dimensions			
	Millimeters		Inches (for reference only)	
	Min.	Max.	Min.	Max.
A1	1.90	2.45	0.074	0.097
A2	0.05	0.20	0.001	0.008
b	1.95	2.20	0.076	0.087
c	0.15	0.40	0.005	0.016
D	3.30	3.95	0.129	0.156
E	5.10	5.60	0.200	0.221
E1	4.05	4.60	0.159	0.182
L	0.75	1.50	0.029	0.060

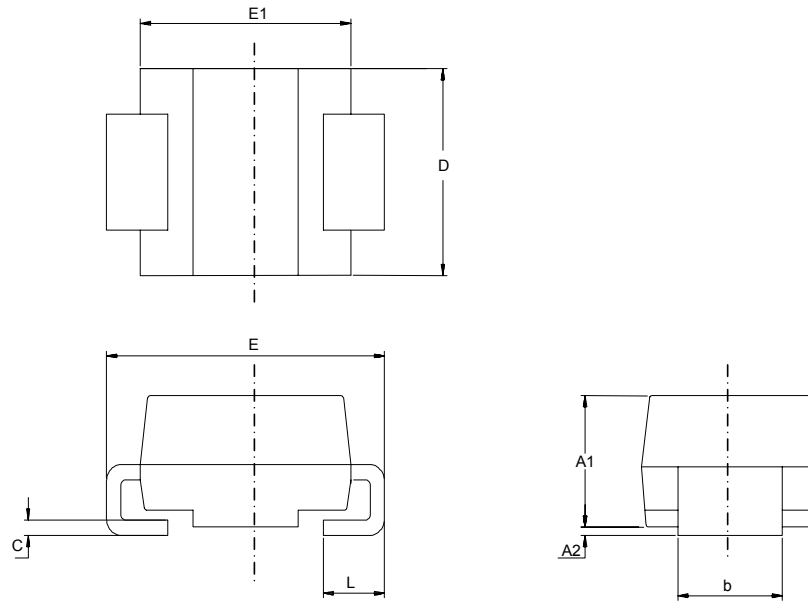
**Figure 17. SMB recommended footprint**



## 2.2 SMA package information

- Epoxy meets UL94, V0
- Cooling method : by conduction (C)

**Figure 18. SMA package outline**

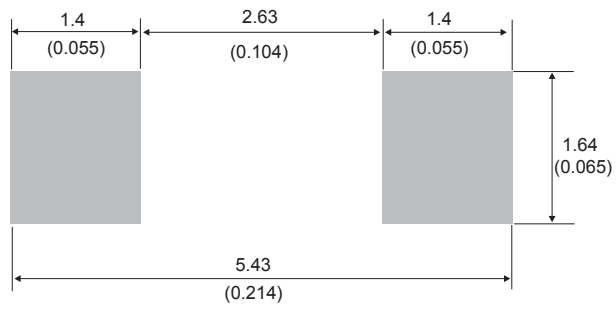


**Table 5. SMA package mechanical data**

Ref.	Dimensions			
	Millimeters		Inches (for reference only)	
	Min.	Max.	Min.	Max.
A1	1.90	2.45	0.074	0.097
A2	0.05	0.20	0.001	0.008
b	1.25	1.65	0.049	0.065
c	0.15	0.40	0.005	0.016
D	2.25	2.90	0.088	0.115
E	4.80	5.35	0.188	0.211
E1	3.95	4.60	0.155	0.182
L	0.75	1.50	0.029	0.060



Figure 19. SMA recommended footprint in mm (inches)



### 2.3 SMA Flat Notch package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Band indicates cathode

Figure 20. SMA Flat Notch package outline

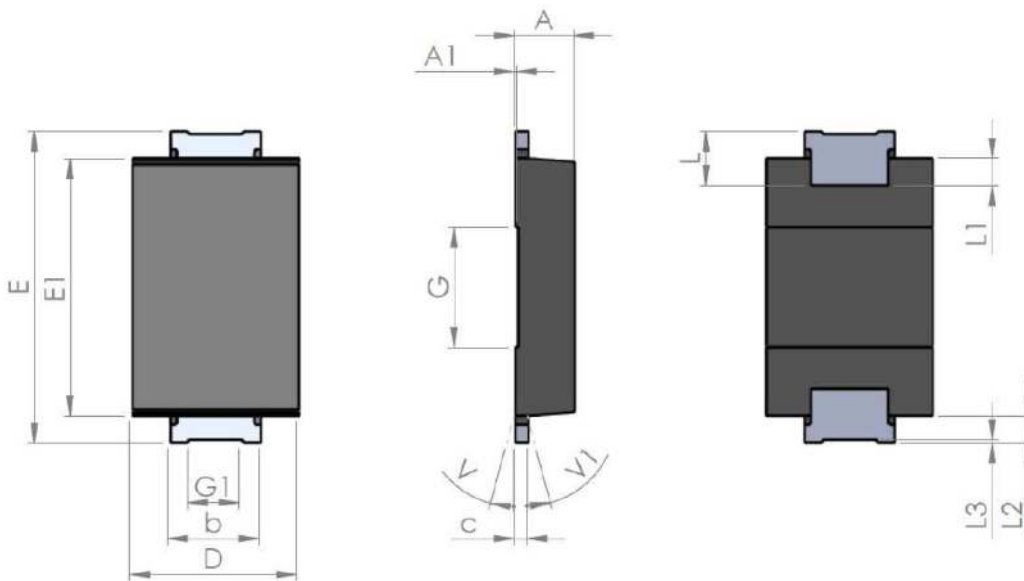
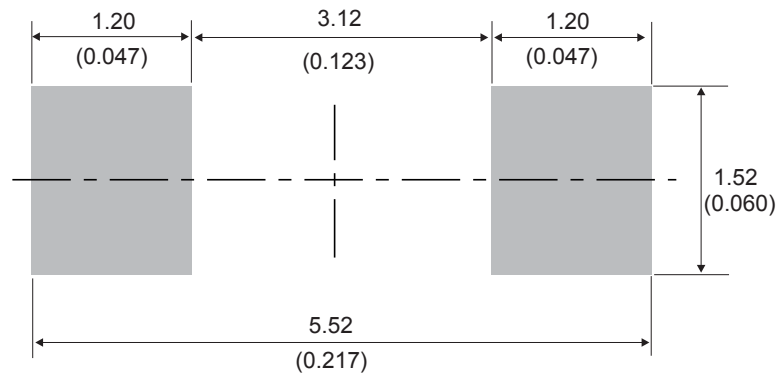


Table 6. SMA Flat Notch package mechanical data

Ref.	Dimensions					
	Millimeters			Inches (for reference only)		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A1	0.90		1.10	0.035		0.044
A1		0.05			0.002	
b	1.25		1.65	0.049		0.065
C	0.15		0.40	0.005		0.016
D	2.25		2.90	0.088		0.115
E	5.00		5.35	0.196		0.211
E1	3.95		4.60	0.155		0.182
G		2.00			0.079	
G1		0.85			0.033	
L	0.75		1.20	0.029		
L1		0.45			0.018	
L2		0.45			0.018	
L3		0.05			0.002	
V			8°			8°
V1			8°			8°

Figure 21. SMA Flat Notch recommended footprint in mm (inches)



## 2.4 SOD123Flat package information

Figure 22. SOD123Flat package outline

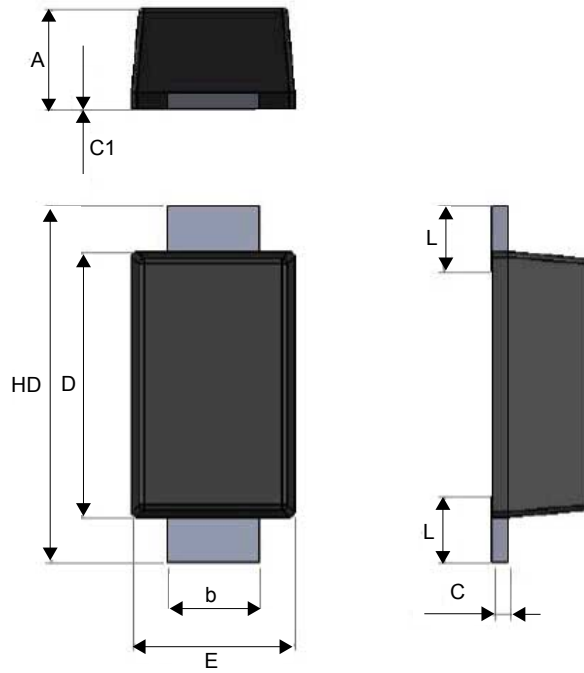
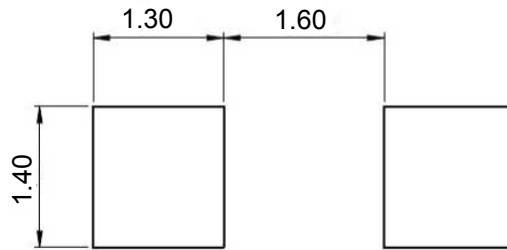


Table 7. SOD123Flat package mechanical data

Ref.	Dimensions					
	Millimeters			Inches (for reference only)		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.86	0.98	1.10	0.034	0.038	0.043
b	0.80	0.90	1.00	0.031	0.035	0.039
c	0.08	0.15	0.25	0.003	0.006	0.009
c1	0.00		0.10	0.000		0.004
D	2.50	2.60	2.70	0.098	0.102	0.106
E	1.50	1.60	1.80	0.059	0.063	0.070
HD	3.30	3.50	3.70	0.130	0.137	0.146
L	0.45	0.65	0.85	0.018	0.025	0.033

Figure 23. SOD123Flat footprint dimensions (mm)



### 3 Ordering information

**Table 8. Ordering information**

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STPS1L40U	GC4	SMB	107 mg	2500	Tape and reel
STPS1L40A	GB4	SMA	68 mg	5000	Tape and reel
STPS1L40AFN	A14	SMA Flat Notch	39 mg	10 000	Tape and reel
STPS1L40ZF	1L4	SOD123Flat	12.5 mg	3000	Tape and reel

## Revision history

**Table 9. Document revision history**

Date	Revision	Changes
Jul-2003	4A	Last update.
Aug-2004	5	SMA package dimensions update. Reference A1 max. changed from 2.70 mm (0.106 inch.) to 2.03 mm (0.080).
24-Jun-2009	6	Added STmite flat package.
01-Jul-2016	7	STmite flat package information removed. Added SOD123Flat package.
03-Dec-2018	8	Updated <a href="#">Section Features</a> and <a href="#">Table 1. Absolute ratings (limiting values at 25 °C, unless otherwise specified)</a> .
27-Sep-2019	9	Added <a href="#">Section 2.3 SMA Flat Notch package information</a> .

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